TOSHIBA Power Transistor Module Silicon NPN Epitaxial Type (Fourd Darlington Power tTransistors in One)

# **MP4020**

**High Power Switching Applications** 

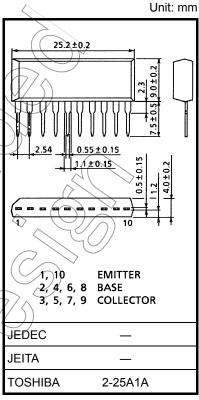
Hammer Drive, Pulse Motor Drive and Inductive Load Switching

- Small package by full molding (SIP 10 pins)
- High collector power dissipation (4-device operation) :  $P_T = 4 \text{ W (Ta} = 25^{\circ}\text{C)}$
- High collector current: IC(DC) = 2 A (max)
- High DC current gain:  $h_{FE} = 2000$  (min) ( $V_{CE} = 2$  V,  $I_{C} = 1$  A)
- · Zener diode included between collector and base

#### Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Collector-base voltage		V <sub>CBO</sub>	50	٧	
Collector-emitter voltage		V <sub>CEO</sub>	60 ± 10	V	
Emitter-base voltage		V <sub>EBO</sub>	80		
Collector current	DC	Ic	2	A	
	Pulse	ICP	)) 3		
Continuous base current		TB <	0.5	\ A	
Collector power dissipation		PC	2.0	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	
(1 device operation)		7/^	2.0		
Collector power dissipati	on	PT	4.07	$\stackrel{\cdot}{\searrow}_{W}$	
(4 devices operation)			(7.0//)	VV	
Junction temperature		T <sub>j</sub>	150	°C	
Storage temperature ran	ge	T <sub>stg</sub>	-55 to 150	°C	

**Industrial Applications** 

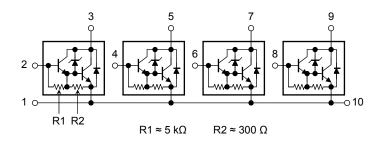


Weight: 2.1 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

### **Array Configuration**





#### **Thermal Characteristics**

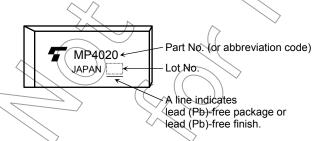
Characteristics	Symbol	Max	Unit	
Thermal resistance from junction to ambient	ΣR <sub>th (j-a)</sub>	31.3	°C/W	
(4-devices operation, Ta = 25°C)				
Maximum lead temperature for soldering purposes	TL	260	°C	
(3.2 mm from case for 10 s)				

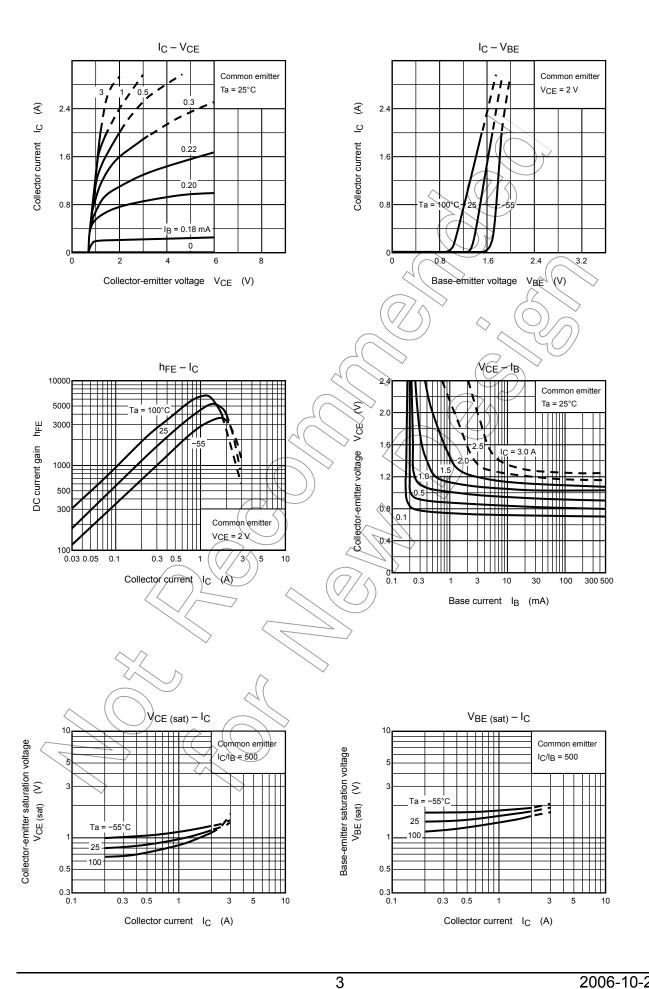
## Electrical Characteristics (Ta = 25°C)

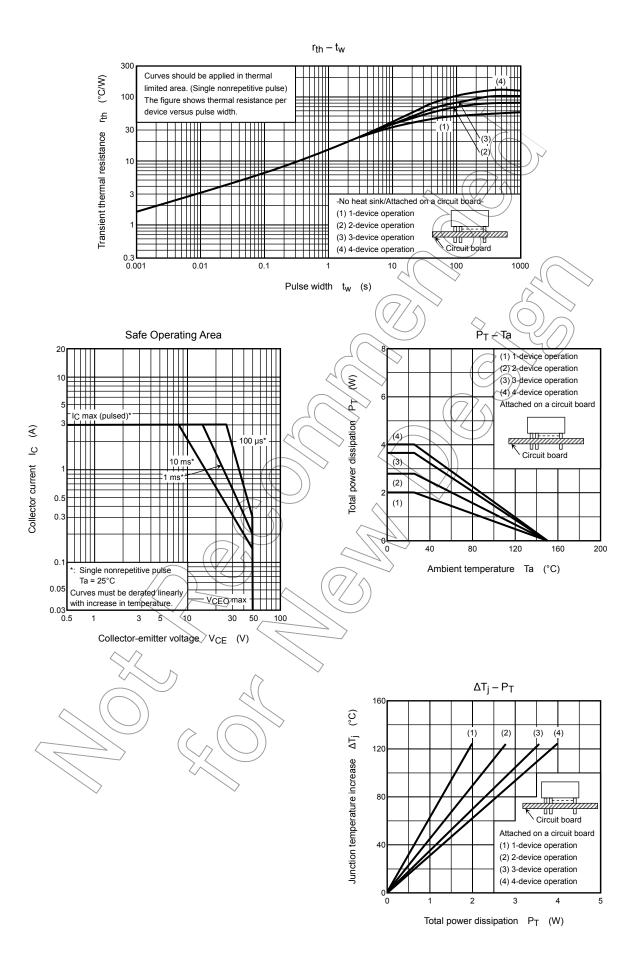
Charac	teristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cut-off cu	rrent	I <sub>CBO</sub>	V <sub>CB</sub> = 45 V, I <sub>E</sub> = 0 A	_		10	μΑ
Collector cut-off cu	rrent	I <sub>CEO</sub>	V <sub>CE</sub> = 45 V, I <sub>B</sub> = 0 A		X+	10	μΑ
Emitter cut-off curre	ent	I <sub>EBO</sub>	V <sub>EB</sub> = 8 V, I <sub>C</sub> = 0 A	0.8	_/	> 4.0	mA
Collector-emitter br	eakdown voltage	V <sub>(BR)</sub> CEO	I <sub>C</sub> = 10 mA, I <sub>B</sub> = 0 A	50	60	70	V
DC current gain		h <sub>FE</sub>	V <sub>CE</sub> = 2 V, (c = 1 A	2000	90)	_	_
Saturation voltage	Collector-emitter	V <sub>CE</sub> (sat)	I <sub>C</sub> = 1 A, I <sub>B</sub> = 1 mA		→ —	1.5	V
	Base-emitter	V <sub>BE</sub> (sat)	I <sub>C</sub> = 1 A, I <sub>B</sub> = 1 mA	( <del>-</del> ])	_	2.0	
Transition frequence	;y	f <sub>T</sub>	V <sub>CE</sub> = 2 V, V <sub>C</sub> = 0.5 A	\ -	100	-	MHz
Collector output ca	pacitance	C <sub>ob</sub>	V <sub>CB</sub> = 10 V, I <sub>E</sub> = 0 A, f = 1 MHz	/ _	20	_	pF
Switching time	Turn-on time	ton	Input B1 Output	_	0.4	_	
	Storage time	tstg	20 μs B2 V <sub>CC</sub> = 30 V	_	4.0		μs
	Fall time	t <sub>f</sub>	1 <sub>B1</sub> = 1 <sub>B2</sub> = 1 mA, duty cycle ≤ 1%	_	0.6	-	

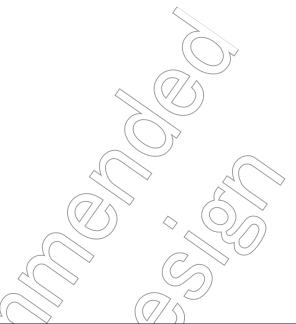
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## Marking









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